

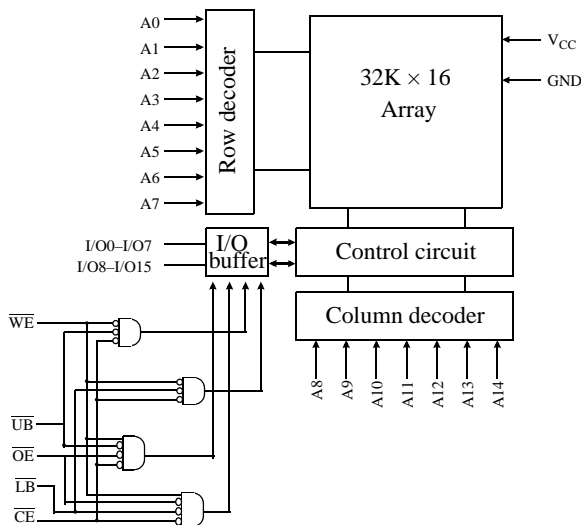


5V 32K×16 CMOS SRAM

**Features**

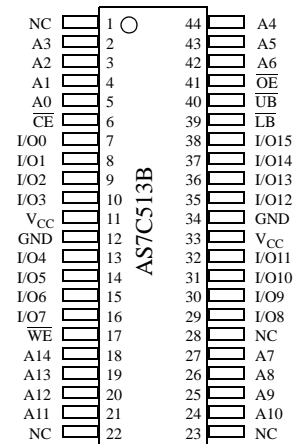
- Industrial and commercial temperature
- Organization: 32,768 words × 16 bits
- Center power and ground pins
- High speed
- 10/12/15/20 ns address access time
- 5, 6, 7, 8 ns output enable access time
- Low power consumption: ACTIVE
- 605mW / max @ 10 ns
- Low power consumption: STANDBY
- 55 mW / max CMOS I/O
- 6T 0.18u CMOS Technology
- Easy memory expansion with  $\overline{CE}$ ,  $\overline{OE}$  inputs
- TTL-compatible, three-state I/O
- 44-pin JEDEC standard package
- 400 mil SOJ
- 400 mil TSOP 2
- ESD protection  $\geq 2000$  volts
- Latch-up current  $\geq 200$  mA

**Logic block diagram**



**Pin arrangement**

44-Pin SOJ, TSOP 2 (400 mil)



**Selection guide**

	-10	-12	-15	-20	Unit
Maximum address access time	10	12	15	20	ns
Maximum output enable access time	5	6	7	8	ns
Maximum operating current	110	100	90	80	mA
Maximum CMOS standby current	10	10	10	10	mA



## Functional description

The AS7C513B is a high performance CMOS 524,288-bit Static Random Access Memory (SRAM) device organized as 32,768 words  $\times$  16 bits. They are designed for memory applications where fast data access, low power, and simple interfacing are desired.

Equal address access and cycle times ( $t_{AA}$ ,  $t_{RC}$ ,  $t_{WC}$ ) of 10/12/15/20 ns with output enable access times ( $t_{OE}$ ) of 5, 6, 7, 8 ns are ideal for high performance applications. The chip enable input  $\overline{CE}$  permits easy memory expansion with multiple-bank memory systems.

When  $\overline{CE}$  is high, the device enters standby mode. If inputs are still toggling, the device consumes  $I_{SB}$  power. If the bus is static, then the full standby power is reached ( $I_{SB1}$ ). The AS7C513B is guaranteed not to exceed 55mW power consumption under nominal full standby conditions.

A write cycle is accomplished by asserting write enable ( $\overline{WE}$ ), ( $\overline{UB}$ ) and/or ( $\overline{LB}$ ), and chip enable ( $\overline{CE}$ ). Data on the input pins I/O0 - I/O7, and/or I/O8 - I/O15, is written on the rising edge of  $\overline{WE}$  (write cycle 1) or  $\overline{CE}$  (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable ( $\overline{OE}$ ) or write enable ( $\overline{WE}$ ).

A read cycle is accomplished by asserting output enable ( $\overline{OE}$ ), ( $\overline{UB}$ ) and ( $\overline{LB}$ ), and chip enable ( $\overline{CE}$ ), with write enable ( $\overline{WE}$ ) high. The chips drive I/O pins with the data word referenced by the input address. When either chip enable or output enable is inactive, or write enable is active, or ( $\overline{UB}$ ) and ( $\overline{LB}$ ), output drivers stay in high-impedance mode.

The devices provide multiple center power and ground pins, and separate byte enable controls, allowing individual bytes to be written and read.  $\overline{LB}$  controls the lower bits, I/O0 - I/O7, and  $\overline{UB}$  controls the higher bits, I/O8 - I/O15.

All chip inputs and outputs are TTL-compatible. The AS7C513B is packaged in common industry standard packages.

## Absolute maximum ratings

Parameter	Symbol	Min	Max	Unit
Voltage on $V_{CC}$ relative to GND	$V_{t1}$	-0.50	+7.0	V
Voltage on any pin relative to GND	$V_{t2}$	-0.50	$V_{CC} + 0.50$	V
Power dissipation	$P_D$	-	1.0	W
Storage temperature (plastic)	$T_{stg}$	-65	+150	$^{\circ}C$
Ambient temperature with $V_{CC}$ applied	$T_{bias}$	-55	+125	$^{\circ}C$
DC current into outputs (low)	$I_{OUT}$	-	20	mA

NOTE: Stresses greater than those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## Truth table

$\overline{CE}$	$\overline{WE}$	$\overline{OE}$	$\overline{LB}$	$\overline{UB}$	I/O0-I/O7	I/O8-I/O15	Mode
H	X	X	X	X	High Z	High Z	Standby ( $I_{SB}$ , $I_{SB1}$ )
L	H	L	L	H	$D_{OUT}$	High Z	Read I/O0-I/O7 ( $I_{CC}$ )
L	H	L	H	L	High Z	$D_{OUT}$	Read I/O8-I/O15 ( $I_{CC}$ )
L	H	L	L	L	$D_{OUT}$	$D_{OUT}$	Read I/O0-I/O15 ( $I_{CC}$ )
L	L	X	L	L	$D_{IN}$	$D_{IN}$	Write I/O0-I/O15 ( $I_{CC}$ )
L	L	X	L	H	$D_{IN}$	High Z	Write I/O0-I/O7 ( $I_{CC}$ )
L	L	X	H	L	High Z	$D_{IN}$	Write I/O8-I/O15 ( $I_{CC}$ )
L	H	H	X	X	High Z	High Z	Output disable ( $I_{CC}$ )
L	X	X	H	H	High Z	High Z	

Key: X = Don't care; L = Low; H = High



### Recommended operating conditions

Parameter	Symbol	Min	Typical	Max	Unit	
Supply voltage	$V_{CC}$	4.5	5	5.5	V	
Input voltage	$V_{IH}$	2.2	-	$V_{CC} + 0.5$		
	$V_{IL}$	-0.5	-	0.8	V	
Ambient operating temperature	commercial	$T_A$	0	-	70	°C
	industrial	$T_A$	-40	-	85	°C

$V_{IL}$  min = -1.0V for pulse width less than 5ns

$V_{IH}$  max =  $V_{CC} + 2.0V$  for pulse width less than 5ns.

### DC operating characteristics (over the operating range)<sup>1</sup>

Parameter	Sym	Test conditions	-10		-12		-15		-20		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
Input leakage current	$ I_{LI} $	$V_{CC} = \text{Max}$ $V_{IN} = \text{GND to } V_{CC}$	-	1	-	1	-	1	-	1	μA
Output leakage current	$ I_{LO} $	$V_{CC} = \text{Max}$ $V_{OUT} = \text{GND to } V_{CC}$	-	1	-	1	-	1	-	1	μA
Operating power supply current	$I_{CC}$	$V_{CC} = \text{Max}$ , $\overline{CE} \leq V_{IL}$ $f = f_{\text{Max}}$ , $I_{OUT} = 0\text{mA}$	-	110	-	100	-	90	-	80	mA
Standby power supply current	$I_{SB}$	$V_{CC} = \text{Max}$ , $\overline{CE} \geq V_{IH}$ $f = f_{\text{Max}}$	-	50	-	45	-	45	-	40	mA
	$I_{SB1}$	$V_{CC} = \text{Max}$ , $\overline{CE} \geq V_{CC} - 0.2V$ $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$ , $f = 0$	-	10	-	10	-	10	-	10	mA
Output voltage	$V_{OL}$	$I_{OL} = 8\text{mA}$ , $V_{CC} = \text{Min}$	-	0.4	-	0.4	-	0.4	-	0.4	V
	$V_{OH}$	$I_{OH} = -4\text{mA}$ , $V_{CC} = \text{Min}$	2.4	-	2.4	-	2.4	-	2.4	-	V

### Capacitance ( $f = 1\text{MHz}$ , $T_a = 25^\circ\text{C}$ , $V_{CC} = \text{NOMINAL}$ )<sup>2</sup>

Parameter	Symbol	Signals	Test conditions	Max	Unit
Input capacitance	$C_{IN}$	A, $\overline{CE}$ , $\overline{WE}$ , $\overline{OE}$ , $\overline{LB}$ , $\overline{UB}$	$V_{in} = 0V$	5	pF
I/O capacitance	$C_{I/O}$	I/O	$V_{in} = V_{out} = 0V$	7	pF

### Read cycle (over the operating range)<sup>3,9</sup>

Parameter	Symbol	-10		-12		-15		-20		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Read cycle time	$t_{RC}$	10	-	12	-	15	-	20	-	ns	
Address access time	$t_{AA}$	-	10	-	12	-	15	-	20	ns	3
Chip enable ( $\overline{CE}$ ) access time	$t_{ACE}$	-	10	-	12	-	15	-	20	ns	3
Output enable ( $\overline{OE}$ ) access time	$t_{OE}$	-	5	-	6	-	7	-	8	ns	
Output hold from address change	$t_{OH}$	3	-	3	-	3	-	3	-	ns	5

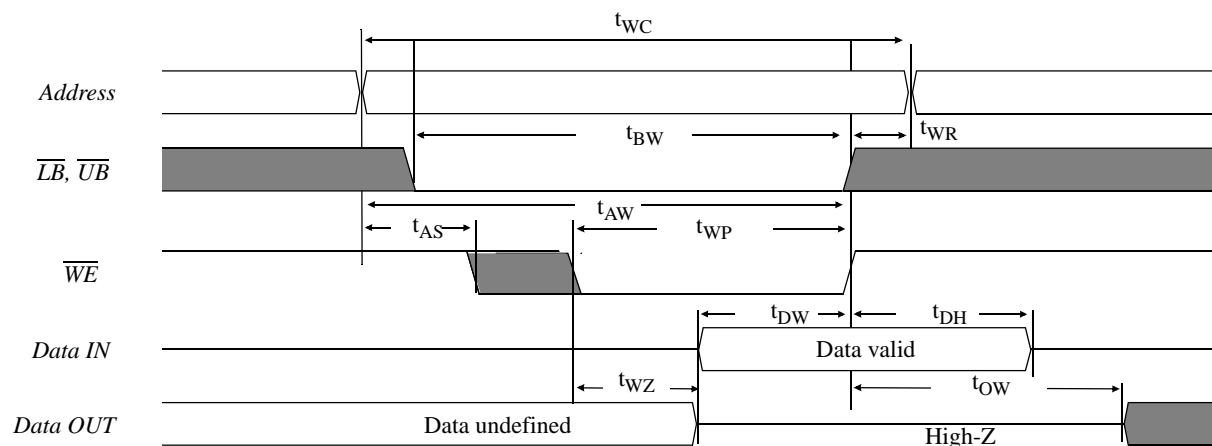




### Write cycle (over the operating range)<sup>11</sup>

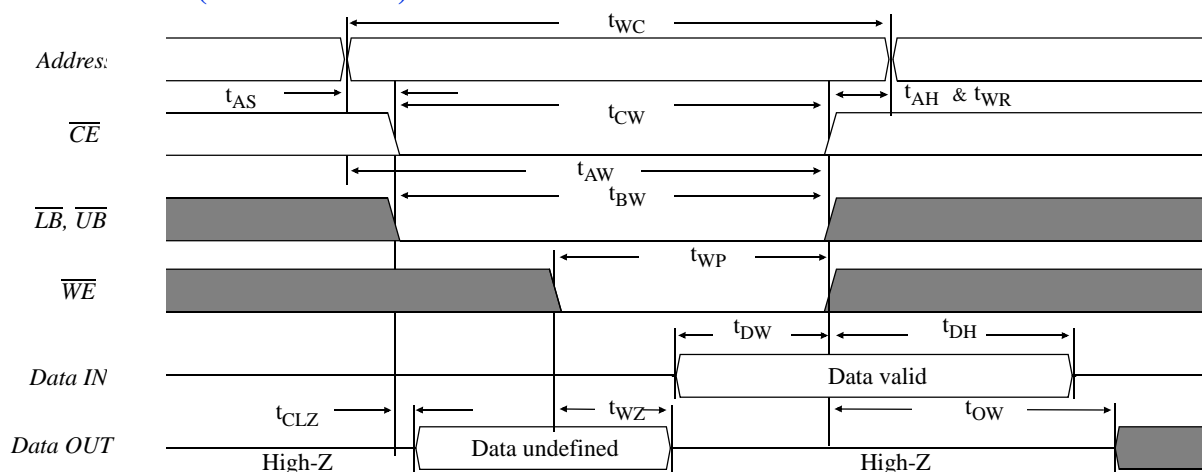
Parameter	Symbol	-10		-12		-15		-20		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Write cycle time	$t_{WC}$	10	–	12	–	15	–	20	–	ns	
Chip enable ( $\overline{CE}$ ) to write end	$t_{CW}$	8	–	9	–	10	–	12	–	ns	
Address setup to write end	$t_{AW}$	8	–	9	–	10	–	12	–	ns	
Address setup time	$t_{AS}$	0	–	0	–	0	–	0	–	ns	
Write pulse width	$t_{WP}$	7	–	8	–	9	–	12	–	ns	
Write recovery time	$t_{WR}$	0	–	0	–	0	–	0	–	ns	
Address hold from end of write	$t_{AH}$	0	–	0	–	0	–	0	–	ns	
Data valid to write end	$t_{DW}$	5	–	6	–	8	–	10	–	ns	
Data hold time	$t_{DH}$	0	–	0	–	0	–	0	–	ns	5
Write enable to output in high Z	$t_{WZ}$	–	5	–	6	–	7	–	8	ns	4, 5
Output active from write end	$t_{OW}$	1	–	1	–	1	–	2	–	ns	4, 5
Byte select low to end of write	$t_{BW}$	7	–	8	–	9	–	9	–	ns	

### Write waveform 1 ( $\overline{WE}$ controlled)<sup>11</sup>





## Write waveform 2 ( $\overline{\text{CE}}$ controlled)<sup>11</sup>



## AC test conditions

- Output load: see Figure B.
- Input pulse level: GND to 3.5V. See Figure A.
- Input rise and fall times: 2 ns. See Figure A.
- Input and output timing reference levels: 1.5V.

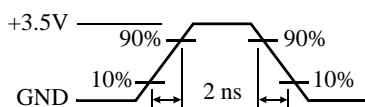


Figure A: Input pulse

Thevenin equivalent:

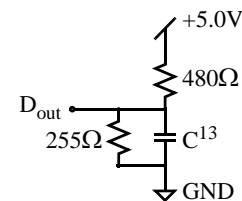
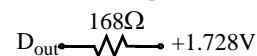


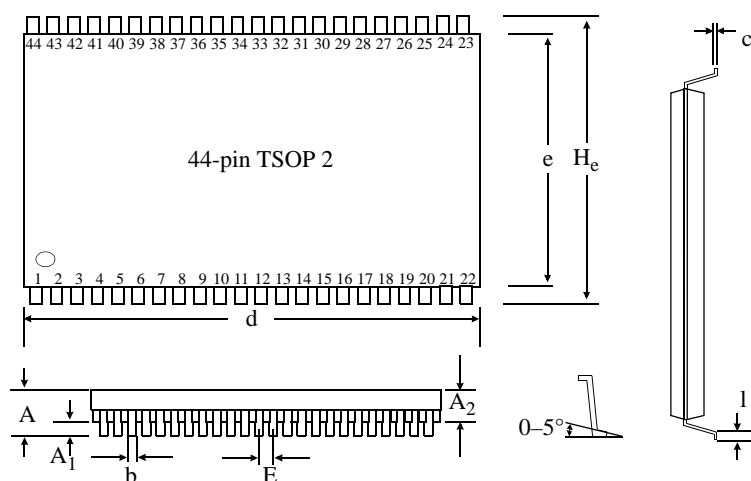
Figure B: 5.0V Output load

## Notes

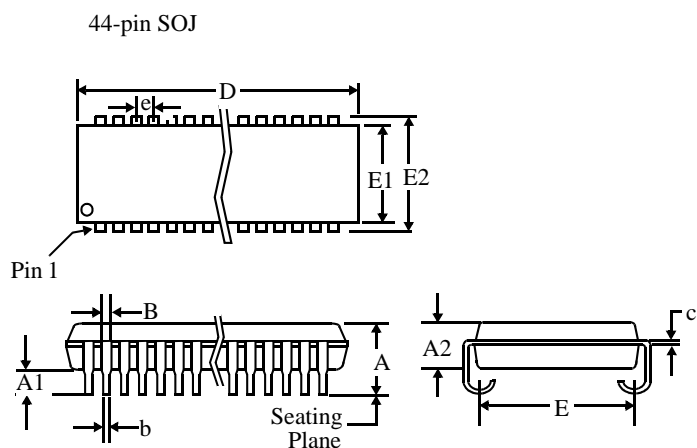
- 1 During  $V_{CC}$  power-up, a pull-up resistor to  $V_{CC}$  on  $\overline{\text{CE}}$  is required to meet  $I_{SB}$  specification.
- 2 This parameter is sampled, but not 100% tested.
- 3 For test conditions, see *AC Test Conditions*, Figures A and B.
- 4 These parameters are specified with  $C_L = 5\text{pF}$ , as in Figure B. Transition is measured  $\pm 500\text{mV}$  from steady-state voltage.
- 5 This parameter is guaranteed, but not 100% tested.
- 6  $\overline{\text{WE}}$  is High for read cycle.
- 7  $\overline{\text{CE}}$  and  $\overline{\text{OE}}$  are Low for read cycle.
- 8 Address valid prior to or coincident with  $\overline{\text{CE}}$  transition Low.
- 9 All read cycle timings are referenced from the last valid address to the first transitioning address.
- 10 Not applicable.
- 11 All write cycle timings are referenced from the last valid address to the first transitioning address.
- 12 Not applicable.
- 13  $C=30\text{pF}$ , except on High Z and Low Z parameters, where  $C=5\text{pF}$ .



Package dimensions



Symbol	44-pin TSOP 2	
	Min (mm)	Max (mm)
A		1.2
A <sub>1</sub>	0.05	0.15
A <sub>2</sub>	0.95	1.05
b	0.3	0.45
c	0.12	0.21
d	18.31	18.52
e	10.06	10.26
H <sub>e</sub>	11.68	11.94
E	0.80 (typical)	
l	0.40	0.60



Symbol	44-pin SOJ 400 mil	
	Min	Max
A	0.128	0.148
A <sub>1</sub>	0.025	-
A <sub>2</sub>	0.105	0.115
B	0.026	0.032
b	0.015	0.020
c	0.007	0.013
D	1.120	1.130
E	0.370 NOM	
E <sub>1</sub>	0.395	0.405
E <sub>2</sub>	0.435	0.445
e	0.050 NOM	



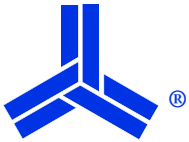
### Ordering codes

Package\Access time		10 ns	12 ns	15 ns	20 ns
Plastic SOJ, 400 mil	Commercial	AS7C513B-10JC	AS7C513B-12JC	AS7C513B-15JC	AS7C513B-20JC
	Industrial	AS7C513B-10JI	AS7C513B-12JI	AS7C513B-15JI	AS7C513B-20JI
TSOP 2, 18.4×10.2 mm	Commercial	AS7C513B-10TC	AS7C513B-12TC	AS7C513B-15TC	AS7C513B-20TC
	Industrial	AS7C513B-10TI	AS7C513B-12TI	AS7C513B-15TI	AS7C513B-20TI

### Part numbering system

AS7C	513B	-XX	X	C
SRAM prefix	Device number	Access time	Package: J = SOJ 400 mil T = TSOP 2 18.4×10.2 mm	Temperature range: C = Commercial, 0°C to 70°C I = Industrial, -40°C to 85°C





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